

# **TDA9111**

# LOW-COST I<sup>2</sup>C CONTROLLED DEFLECTION PROCESSOR FOR MULTISYNC MONITOR

#### **FEATURES**

### General

- SYNC PROCESSOR (separate or composite)
- 12V SUPPLY VOLTAGE
- 8V REFERENCE VOLTAGE
- HOR. LOCK/UNLOCK OUTPUT
- HOR. & VERT. LOCK/UNLOCK INDICATION
- READ/WRITE I<sup>2</sup>C INTERFACE
- HORIZONTAL AND VERTICAL MOIRE
- B+ REGULATOR
  - Internal PWM generator for B+ current mode step-up converter

  - Switchable to step-down converter I<sup>2</sup>C adjustable B+ reference voltage
  - Output pulses synchronized on horizontal frequency
  - Internal maximum current limitation.

#### Horizontal

- Self-adaptative
- Dual PLL concept
- 150kHz maximum frequency
- X-Ray protection input
- I<sup>2</sup>C controls: Horizontal duty-cycle, H-position, horizontal size amplitude

#### **Vertical**

- Vertical ramp generator
- 50 to 185Hz AGC loop
- Geometry tracking with VPOS & VAMP
- I<sup>2</sup>C controls: VAMP, VPOS, S-CORR, C-CORR
- DC breathing compensation

## I<sup>2</sup>C Geometry corrections

- Vertical parabola generator (Pin Cushion E/W, Keystone, Corner Correction)
- Horizontal dynamic phase (Side Pin Balance & Parallelogram)
- Horizontal and vertical dynamic focus (Horizontal Focus Amplitude, Horizontal Focus Symmetry, Vertical Focus Amplitude)

#### DESCRIPTION

The TDA9111 is a monolithic integrated circuit assembled in a 32-pin shrink dual-in-line plastic package. This IC controls all the functions related to horizontal and vertical deflection in multimode or multi-frequency computer display monitors.

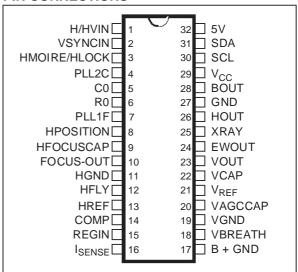
The internal sync processor, combined with the powerful geometry correction block, makes the TDA9111 suitable for very high performance monitors, using few external components.

The horizontal jitter level is very low. It is particularly well-suited to high-end 15" and 17" monitors.

Combined with the ST7275 Microcontroller family, TDA9206 (Video preamplifier) and STV942x (On-Screen Display controller), the TDA9111 allows fully-I<sup>2</sup>C bus-controlled computer display monitors to be built with a reduced number of external components.



#### PIN CONNECTIONS



Version 4.2

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# **PIN CONNECTIONS**

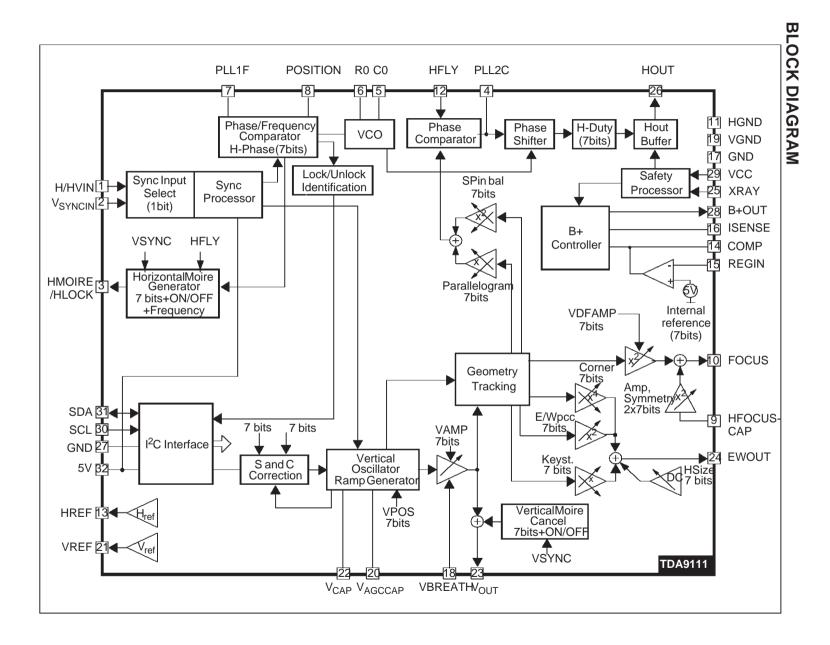
| Pin | Name               | Function  |
|-----|--------------------|---|
| 1   | H/HVIN             | TTL compatible Horizontal sync Input (separate or composite)  |
| 2   | VSYNCIN            | TTL compatible Vertical sync Input (for separated H&V)  |
| 3   | HMOIRE/<br>HLOCK   | Horizontal Moiré Output (to be connected to PLL2C through a resistor divider), HLock Output   |
| 4   | PLL2C              | Second PLL Loop Filter  |
| 5   | C0                 | Horizontal Oscillator Capacitor   |
| 6   | R0                 | Horizontal Oscillator Resistor  |
| 7   | PLL1F              | First PLL Loop Filter   |
| 8   | HPOSITION          | Horizontal Position Filter (capacitor to be connected to HGND)  |
| 9   | HFOCUS-<br>CAP     | Horizontal Dynamic Focus Oscillator Capacitor   |
| 10  | FOCUS OUT          | Mixed Horizontal and Vertical Dynamic Focus Output  |
| 11  | HGND               | Horizontal Section Ground   |
| 12  | HFLY               | Horizontal Flyback Input (positive polarity)  |
| 13  | HREF               | Horizontal Section Reference Voltage (to be filtered)   |
| 14  | COMP               | B+ Error Amplifier Output for frequency compensation and gain setting   |
| 15  | REGIN              | Feedback Input of B+ control loop   |
| 16  | I <sub>SENSE</sub> | Sensing of external B+ switching transistor current, or switch for step-down converter  |
| 17  | B+GND              | Ground (related to B+ reference)  |
| 18  | VBREATH            | V Breathing Input Control (compensation of vertical amplitude against EHV variation)  |
| 19  | VGND               | Vertical Section Ground   |
| 20  | VAGCCAP            | Memory Capacitor for Automatic Gain Control in Vertical Ramp Generator  |
| 21  | V <sub>REF</sub>   | Vertical Section Reference Voltage (to be filtered)   |
| 22  | VCAP               | Vertical Sawtooth Generator Capacitor   |
| 23  | VOUT               | Vertical Ramp Output (with frequency-independent amplitude and S or C Corrections if any). It is mixed with vertical position voltage and vertical moiré. |
| 24  | EWOUT              | Pin Cushion (E/W) Correction Parabola Output  |
| 25  | XRAY               | X-RAY protection input (with internal latch function)   |
| 26  | HOUT               | Horizontal Drive Output (open collector)  |
| 27  | GND                | General Ground  |
| 28  | BOUT               | B+ PWM Regulator Output   |
| 29  | V <sub>CC</sub>    | Supply Voltage(12V typ) (referenced to Pin 27)  |
| 30  | SCL                | I <sup>2</sup> C Clock Input  |
| 31  | SDA                | I <sup>2</sup> C Data Input   |
| 32  | 5V                 | 5V Supply Voltage   |



# **QUICK REFERENCE DATA**

| Parameter   | Value       | Unit |
|---|-------------|------|
| Any polarity on H Sync & V Sync inputs  | YES         |      |
| TTL or composite Syncs  | YES         |      |
| Sync on Green   | NO          |      |
| Horizontal Frequency  | 15 to 150   | kHz  |
| Horizontal Autosync Range (for given R0 and C0. Can be easily increased by application)           | 1 to 4.5 f0 |      |
| Control of free-running frequency   | NO          |      |
| Frequency Generator for Burn-in   | NO          |      |
| Control of H-Position through I <sup>2</sup> C  | YES         |      |
| Control for H-Duty Cycle through I <sup>2</sup> C   | 30 to 65    | %    |
| PLL1 Inhibition Possibility   | NO          |      |
| Output for Horizontal Lock/Unlock   | YES         |      |
| Dual Polarity H-Drive Outputs   | NO          |      |
| Vertical Frequency  | 35 to 200   | Hz   |
| Vertical Autosync Range (for 150nF on Pin 22 and 470nF on Pin 20)                                 | 50 to 185   | Hz   |
| Vertical S-Correction (adapted to normal or super flat tube), controlled through I <sup>2</sup> C | YES         |      |
| Vertical C-Correction, controlled through I <sup>2</sup> C  | YES         |      |
| Control of Vertical Amplitude through I <sup>2</sup> C  | YES         |      |
| Control of Vertical Position through I <sup>2</sup> C   | YES         | 1    |
| Input for Vertical Amplitude compensation versus EHV  | YES         |      |
| E/W Correction Output (also known as Pin Cushion Output)  | YES         |      |
| Horizontal Size Adjustment through I <sup>2</sup> C control of E/W Output DC level                | YES         | 1    |
| Control of E/W (Pincushion) Adjustment through I <sup>2</sup> C                                   | YES         | 1    |
| Control of Keystone (Trapezoïd) Adjustment through I <sup>2</sup> C                               | YES         |      |
| Control of Corner Adjustment through I <sup>2</sup> C   | YES         | 1    |
| Fully integrated Dynamic Horizontal Phase Control   | YES         |      |
| Control of Side Pin Balance through I <sup>2</sup> C  | YES         |      |
| Control of Parallelogram through I <sup>2</sup> C   | YES         |      |
| H/V composite Dynamic Focus Output  | YES         |      |
| Control of Horizontal Dynamic Focus Amplitude through I <sup>2</sup> C                            | YES         |      |
| Control of Horizontal Dynamic Focus Symmetry through I <sup>2</sup> C                             | YES         |      |
| Control of Vertical Dynamic Focus Amplitude through I <sup>2</sup> C                              | YES         |      |
| Tracking of Geometric Corrections and of Vertical focus with Vertical Amplitude and Position      | YES         |      |
| Control of Horizontal and Vertical Moiré cancellations through I <sup>2</sup> C                   | YES         |      |
| Optimisation of HMoiré frequency through I <sup>2</sup> C   | YES         |      |
| B+ Regulation, adjustable through I <sup>2</sup> C  | YES         |      |
| Stand-by function, disabling H and V scanning and B+  | YES         |      |
| X-Ray protection, disabling H scanning and B+   | YES         | 1    |
| Blanking Outputs  | NO          | 1    |
| Fast I <sup>2</sup> C Read/Write  | 400         | kHz  |
| I <sup>2</sup> C indication of the presence of Syncs (biased from 5V alone)                       | YES         | 1    |
| I <sup>2</sup> C indication of the polarity and Type of Syncs                                     | YES         | 1    |
| I <sup>2</sup> C indication of Lock/Unlock, for both Horizontal and Vertical sections             | YES         | 1    |





# **ABSOLUTE MAXIMUM RATINGS**

| Symbol            |                                  | Parameter   | Value   | Unit                  |
|-------------------|----------------------------------|---|---|-----------------------|
| V <sub>CC</sub>   | Supply Voltage (Pi               | Supply Voltage (Pin 29)   |   | V                     |
| $V_{DD}$          | Supply Voltage (Pi               | າ 32)   | 5.7   | V                     |
| V <sub>IN</sub>   | Max Voltage on                   | Pin 4 Pin 9 Pin 5 Pins 6, 7, 8, 14, 15, 16, 20, 22 Pins 3, 10, 18, 23, 24, 25, 26, 28 Pins 1, 2 Pins 30, 31 | 4.0<br>5.5<br>6.4<br>8.0<br>V <sub>CC</sub><br>V <sub>DD</sub><br>5 | V<br>V<br>V<br>V<br>V |
| VESD              | ESD susceptibility through 1.5kΩ | Human Body Model, 100pF Discharge EIAJ Norm, 200pF Discharge through $0\Omega$                              | 2<br>300  | kV<br>V               |
| T <sub>stg</sub>  | Storage Temperatu                | ire   | -40, +150   | °C                    |
| T <sub>j</sub>    | Junction Temperat                | ure   | +150  | °C                    |
| T <sub>oper</sub> | Operating Tempera                | ature   | 0, +70  | °C                    |

# THERMAL DATA

| Symbol               | Parameter                                | Value | Unit |
|----------------------|--|-------|------|
| R <sub>th(j-a)</sub> | Max. Junction-Ambient Thermal Resistance | 65    | °C/W |

# **SUPPLY AND REFERENCE VOLTAGES**

**Electrical Characteristics** (V<sub>CC</sub> = 12V, T<sub>amb</sub> = 25°C

| Symbol             | Parameter                                  | Test Conditions  | Min. | Тур. | Max. | Units |
|--------------------|--|------------------|------|------|------|-------|
| V <sub>CC</sub>    | Supply Voltage                             | Pin 29           | 10.8 | 12   | 13.2 | V     |
| V <sub>DD</sub>    | Supply Voltage                             | Pin 32           | 4.5  | 5    | 5.5  | V     |
| I <sub>CC</sub>    | Supply Current                             | Pin 29           |      | 50   |      | mA    |
| I <sub>DD</sub>    | Supply Current                             | Pin 32           |      | 5    |      | mA    |
| V <sub>REF-H</sub> | Horizontal Reference Voltage               | Pin 13, I = -2mA | 7.6  | 8.2  | 8.8  | V     |
| V <sub>REF-V</sub> | Vertical Reference Voltage                 | Pin 21, I = -2mA | 7.6  | 8.2  | 8.8  | V     |
| I <sub>REF-H</sub> | Max. Sourced Current on V <sub>REF-H</sub> | Pin 13           |      |      | 5    | mA    |
| I <sub>REF-V</sub> | Max. Sourced Current on V <sub>REF-V</sub> | Pin 21           |      |      | 5    | mA    |

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# I<sup>2</sup>C READ/WRITE

**Electrical Characteristics** ( $V_{DD} = 5V$ ,  $T_{amb} = 25^{\circ}C$ )

| Symbol                   | Parameter   | Test Conditions                          | Min. | Тур. | Max. | Units    |
|--------------------------|---|--|------|------|------|----------|
| I <sup>2</sup> C PROCESS | SOR <sup>(1)</sup>                                    |  |      |      |      |          |
| Fscl                     | Maximum Clock Frequency                               | Pin 30                                   |      |      | 400  | kHz      |
| Tlow                     | Low period of the SCL Clock                           | Pin 30                                   | 1.3  |      |      | μs       |
| Thigh                    | High period of the SCL Clock                          | Pin 30                                   | 0.6  |      |      | μs       |
| Vinth                    | SDA and SCL Input Threshold                           | Pins 30, 31                              |      | 2.2  |      | V        |
| VACK                     | Acknowledged Output Voltage on SDA input with 3mA     | Pin 31                                   |      |      | 0.4  | <b>V</b> |
| I <sup>2</sup> C leak    | Leakage current into SDA and SCL with no logic supply | V <sub>DD</sub> = 0<br>Pins 30, 31 = 5 V |      |      | 20   | μΑ       |

Note: 1 See also I<sup>2</sup>C Sub Address Table.

# **SYNC PROCESSOR**

**Operating Conditions**  $(V_{DD} = 5V, V_{CC} = 12V, T_{amb} = 25^{\circ}C)$ 

| Symbol | Parameter  | Test Conditions | Min. | Тур. | Max. | Units |
|--------|--|-----------------|------|------|------|-------|
| HSVR   | Voltage on H/HVIN Input                          | Pin 1           | 0    |      | 5    | V     |
| MinD   | Minimum Horizontal Input Pulses Duration         | Pin 1           | 0.7  |      |      | μs    |
| Mduty  | Maximum Horizontal Input Signal Duty Cycle       | Pin 1           |      |      | 25   | %     |
| VSVR   | Voltage on VSYNCIN                               | Pin 2           | 0    |      | 5    | V     |
| VSW    | Minimum Vertical Sync Pulse Width                | Pin 2           | 5    |      |      | μs    |
| VSmD   | Maximum Vertical Sync Input Duty Cycle           | Pin 2           |      |      | 15   | %     |
| VextM  | Maximum Vertical Sync Width on TTL H/ Vcomposite | Pin 1           |      |      | 750  | μs    |

**Electrical Characteristics** (V<sub>DD</sub> = 5V, V<sub>CC</sub> = 12V, T<sub>amb</sub> = 25°C)

| Symbol | Parameter  | Test Conditions         | Min. | Тур. | Max. | Units  |
|--------|--|-------------------------|------|------|------|--------|
| VINTH  | Horizontal and Vertical Input Logic Level (Pins 1, 2)                                  | High Level<br>Low Level | 2.2  |      | 0.8  | V<br>V |
| RIN    | Horizontal and Vertical Pull-Up Resistor   | Pins 1, 2               |      | 250  |      | kΩ     |
| VoutT  | Extracted Vsync Integration Time (% of T <sub>H</sub> ) on H/VComposite <sup>(2)</sup> | C0 = 820pF              | 26   | 35   |      | %      |

Note: 2 T<sub>H</sub> is the horizontal period.

# **HORIZONTAL SECTION**

# **Operating Conditions**

| Symbol            | Parameter                               | Test Conditions      | Min. | Тур. | Max. | Units |
|-------------------|---|----------------------|------|------|------|-------|
| VCO               |   |                      |      |      | ,    | ,     |
| I <sub>0max</sub> | Max Current from Pin 6                  | Pin 6                |      |      | 1.5  | mA    |
| F(max.)           | Maximum Oscillator Frequency            |                      |      |      | 150  | kHz   |
| OUTPUT SEC        | TION                                    |                      |      |      |      |       |
| l12m              | Maximum Input Peak Current              | Pin 12               |      |      | 5    | mA    |
| НОІ               | Horizontal Drive Output Maximum Current | Pin 26, Sunk current |      |      | 30   | mA    |

Electrical Characteristics (V<sub>CC</sub> = 12V, T<sub>amb</sub> = 25°C)

| Symbol                 | Parameter   | Test Conditions  | Min. | Тур.                                     | Max. | Units       |
|------------------------|---|--|------|--|------|-------------|
| 1st PLL SECT           | ION   |  |      | 1  |      |             |
| HpoIT                  | Delay Time for detecting polarity change <sup>(3)</sup>   | Pin 1  | 0.75 |  |      | ms          |
| Vvco                   | VCO Control Voltage (Pin 7)   | $V_{REF-H} = 8.2V$ $f_H = f_0$ $f_{H=}f_H \text{ (Max.)}$            |      | 1.4<br>6.4                               |      | V           |
| Vcog                   | VCO Gain (Pin 7)  | $R_0 = 6.49k\Omega$ ,<br>$C_0 = 820pF$                               | Tbd  | 15.9                                     | Tbd  | kHz/V       |
| Hph                    | Horizontal Phase Adjustment (4)   | % of Horizontal<br>Period  |      | ±10                                      |      | %           |
| Vbmi<br>Vbtyp<br>Vbmax | Horizontal Phase Setting Value (Pin 8) <sup>(4)</sup> Minimum Value Typical Value Maximum Value | Sub-Address 01  Byte x1111111  Byte x1000000  Byte x0000000          |      | 2.9<br>3.5<br>4.2                        |      | V<br>V<br>V |
| IPII1U<br>IPII1L       | PLL1 Filter Charge Current  | PLL1 is Unlocked<br>PLL1 is Locked                                   |      | ±140<br>±1                               |      | μA<br>mA    |
| f <sub>o</sub>         | Free Running Frequency  | $R_0 = 6.49k\Omega$ , $C_0 = 820pF$                                  | Tbd  | 22.8                                     | Tbd  | kHz         |
| dfo/dT                 | Free Running Frequency Thermal Drift (5)  | Not including external componant drift                               |      | -150                                     |      | ppm/C       |
| CR                     | PLL1 Capture Range  | fH(Min.)<br>fH(Max.) <sup>(6)</sup>                                  |      | f <sub>o</sub> +0.5<br>4.5f <sub>o</sub> |      | kHz<br>kHz  |
| HUnlock                | DC level pin 3 when PLL1 is unlocked  | Sub-address 02<br>1xxx xxxx<br>0000 0000<br>0111 1111 <sup>(7)</sup> | 6    | 0.3<br>2.75                              | 3    | V<br>V<br>V |

| Symbol         | Parameter   | Test Conditions  | Min. | Тур.       | Max. | Units  |
|----------------|---|--|------|------------|------|--------|
| 2nd PLL SEC    | TION AND HORIZONTAL OUTPUT SECT   | ON   |      |            |      |        |
| FBth           | Flyback Input Threshold Voltage (Pin 12)  |  | 0.65 | 0.75       |      | V      |
| Hjit           | Horizontal Jitter (8)   | At 31.4kHz   |      | 70         |      | ppm    |
| HDmin<br>HDmax | Horizontal Drive Output Duty-Cycle (Pin 26) (9)   | Sub-Address 00<br>Byte x1111111<br>Byte x0000000 <sup>(10)</sup> |      | 30<br>65   |      | %<br>% |
| XRAYth         | X-RAY Protection Input Threshold Voltage,   | Pin 25, (see fig. 14)  | 7.6  | 8.2        | 8.8  | V      |
| Vphi2          | Internal Clamping Levels on 2nd PLL Loop Filter (Pin 4)   | Low Level<br>High Level  |      | 1.6<br>4.2 |      | V      |
| VSCinh         | Inhibition threshold (The condition V <sub>CC</sub> < VSCinh will stop H-Out, V-Out, B-Out and reset X-RAY) |  |      | 7.5        |      | V      |
| HDvd           | Horizontal Drive Output (low level)   | Pin 26, I <sub>OUT</sub> = 30mA                                  |      |            | 0.4  | V      |

Note: 3 This delay is necessary to avoid a wrong detection of polarity change in the case of a composite sync.

- 4 See Figure 10 for explanation of reference phase.
- 5 These parameters are not tested on each unit. They are measured during our internal qualification.
- 6 A larger range may be obtained by application.
- 7 When at 0xxx xxxx, (HMoiré/HLock not selected), Pin 3 is a DAC with 0.3...2.75V range. When at 1xxx xxxx (HMoiré/HLock selected) and PLL1 is locked, Pin 3 provides the waveform for HMoiré. See also Moiré section
- 8 Hjit =  $10^6$ x(Standard deviation/Horizontal period).
- 9 Duty Cycle is the ratio between the output transistor OFF time and the period. The scanning transistor is controlled OFF when the output transistor is OFF.
- 10 Initial Condition for Safe Start Up.

## **VERTICAL SECTION**

# **Operating Conditions**

| Symbol            | Parameter  | Test Conditions | Min. | Тур. | Max. | Units |
|-------------------|--|-----------------|------|------|------|-------|
| R <sub>LOAD</sub> | Minimum Load for less than 1% Vertical Amplitude Drift | Pin 20          | 65   |      |      | МΩ    |

Electrical Characteristics (V<sub>CC</sub> = 12V, T<sub>amb</sub> = 25°C)

| Symbol | Parameter  | Test Conditions   | Min. | Тур.               | Max. | Units       |
|--------|--|---|------|--------------------|------|-------------|
| VRB    | Voltage at Ramp Bottom Point   | Pin 22  |      | 2.1                |      | V           |
| VRT    | Voltage at Ramp Top Point (with Sync)  | Pin 22  |      | 5.1                |      | V           |
| VRTF   | Voltage at Ramp Top Point (without Sync)   | Pin 22  |      | VRT-<br>0.1        |      | V           |
| VSTD   | Vertical Sawtooth Discharge Time   | Pin 22, C <sub>22</sub> = 150nF   |      | 70                 |      | μs          |
| VFRF   | Vertical Free Running Frequency (12)   | Pin 22, C <sub>22</sub> = 150nF   |      | 100                |      | Hz          |
| ASFR   | AUTO-SYNC Frequency (13)   | C <sub>22</sub> = 150nF ±5%   | 50   |                    | 185  | Hz          |
| RAFD   | Ramp Amplitude Drift Versus Frequency at Maximum Vertical Amplitude (11)   | C <sub>22</sub> = 150nF<br>50Hz< f < 185Hz  |      | 200                |      | ppm/<br>Hz  |
| Rlin   | Ramp Linearity on Pin 22 (12)  | 2.5V < V <sub>27</sub> < 4.5V   |      | 0.5                |      | %           |
| VPOS   | Vertical Position Adjustment Voltage (Pin 23 - VOUT mean value)  | Sub Address 06 Byte 00000000 Byte 01000000 Byte 01111111  | Tbd  | 3.2<br>3.6<br>4.0  | Tbd  | > >         |
| VOR    | Vertical Output Voltage<br>(peak-to-peak on Pin 23)  | Sub Address 05 Byte 10000000 Byte 11000000 Byte 11111111  | Tbd  | 2.15<br>3.0<br>3.9 | Tbd  | > >         |
| VOI    | Vertical Output Maximum Current (Pin 23)   |   |      | ±5                 |      | mA          |
| dVS    | Max Vertical S-Correction Amplitude (TV is the vertical period) (0xxxxxxx inhibits S-CORR 11111111 gives max S-CORR) | Sub Address 07 Byte 11111111 $\Delta V/V_{PP}$ at $TV/4$ $\Delta V/V_{PP}$ at $3TV/4$           |      | -3.5<br>+3.5       |      | %<br>%      |
| Ccorr  | Vertical C-Corr Amplitude<br>(0xxxxxxx inhibits C-CORR)  | Sub Address 08<br>∆V/V <sub>PP</sub> at TV/2<br>Byte 10000000<br>Byte 11000000<br>Byte 11111111 |      | -3<br>0<br>+3      |      | %<br>%<br>% |
| BRRANG | DC Breathing Control Range (14)  | V <sub>18</sub>   | 1    |                    | 12   | V           |
| BRADj  | Vertical Output Variation versus DC<br>Breathing Control (Pin 23)  | $V_{18} \ge V_{REF-V}$<br>1V< $V_{18}$ < $V_{REF-V}$  |      | 0<br>-2.5          |      | %/V<br>%/V  |

Note: 11 These parameters are not tested on each unit. They are measured during our internal qualification procedure.

Note: 14 When not used, the DC breathing control pin must be connected to 12V.

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Note: 12 Set Register 07 at Byte 0xxxxxxx (S correction inhibited) and Register 08 at Byte 0xxxxxxx (C correction inhibited), to obtain a vertical sawtooth with linear shape.

Note: 13 This is the frequency range for which the vertical oscillator will automatically synchronize, using a single capacitor value on Pin22 and Pin 20, and with a constant ramp amplitude.

# **DYNAMIC FOCUS SECTION**

Electrical Characteristics ( $V_{CC} = 12V$ ,  $T_{amb} = 25^{\circ}C$ )

| Symbol      | Parameter Parameter  | Test Conditions   | Min. | Тур.            | Max. | Units   |
|-------------|--|---|------|-----------------|------|---|
| HORIZONTAL  | DYNAMIC FOCUS FUNCTION (see Figur  | e 15 on page 29)  |      |                 |      |   |
| HDFst       | Horizontal Dynamic Focus Sawtooth<br>Minimum Level<br>Maximum Level  | Pin 9, capacitor on HFO-<br>CUSCAP and<br>C0 = 820pF, T <sub>H</sub> = 20μs                       |      | 2.2<br>4.9      |      | V   |
| HDFdis      | Horizontal Dynamic Focus Sawtooth Discharge Width  | Triggered by HDFstart   |      | 400             |      | ns  |
| HDFstart    | Internal Phase Advance versus HFLY middle (Independent of frequency)   |   |      | 1               |      | μs  |
| HDFDC       | Bottom DC Output Level   | $R_{LOAD} = 10k\Omega$ ,<br>Pin 10  |      | 2.1             |      | V   |
| TDFHD       | DC Output Voltage Thermal Drift (11)   |   |      | 200             |      | ppm/C   |
| HDFamp      | Horizontal Dynamic Focus Amplitude  Max Byte Typ Byte Max Byte   | Sub-Address 03,<br>Pin 10, fH = 50kHz,<br>Symmetric Wave Form<br>x1111111<br>x1000000<br>x0000000 |      | 1<br>1.5<br>3.5 |      | V <sub>PP</sub><br>V <sub>PP</sub><br>V <sub>PP</sub> |
| HDFKeyst    | Horizontal Dynamic FocusSymmetry<br>(For time reference, see Figure 15 )<br>Advance for Byte<br>Delay for Byte       | Subaddress 04<br>x1111111 (decimal 127)<br>x0000000 (decimal 0)                                   |      | 16<br>16        |      | %<br>%  |
| VERTICAL DY | NAMIC FOCUS FUNCTION (see Figure 1   | )   |      |                 |      |   |
| AMPVDF      | Vertical Dynamic Focus Parabola (added to horizontal) Amplitude with VAMP and VPOS Typical                           | Sub-Address 0F<br>Min Byte x0000000<br>Typ Byte x1000000<br>Max Byte x1111111                     |      | 0<br>0.5<br>1   |      | V <sub>PP</sub><br>V <sub>PP</sub><br>V <sub>PP</sub> |
| VDFAMP      | Parabola Amplitude Function of VAMP (tracking between VAMP and VDF) with VPOS Typ. (seeFigure 1 on page 15 and (15)) | Sub-Address 05  Byte x0000000  Byte x1000000  Byte x1111111                                       |      | 0.6<br>1<br>1.5 |      | V <sub>PP</sub><br>V <sub>PP</sub>                    |
| VHDFKeyt    | Parabola Asymmetry Function of VPOS Control (tracking between VPOS and VDF) with VAMP Max. B/A Ratio A/B Ratio       | Sub-Address 06  Byte x0000000  Byte x1111111  |      | 0.52<br>0.52    |      |   |

Note: 15 S and C correction are inhibited to obtain a linear vertical sawtooth.

# **GEOMETRY CONTROL SECTION**

**Electrical Characteristics** (V<sub>CC</sub> = 12V, T<sub>amb</sub> = 25°C)

| Symbol             | Parameter   | Test Conditions   | Min.     | Тур.                | Max.      | Units   |
|--------------------|---|---|----------|---------------------|-----------|---|
| SYMMETRIC C        | ONTROL THROUGH E/W OUTPUT (see  | Figure 2 on page 15 and I   | Figure 4 | on pag              | e 15)     |   |
| VEWM               | Maximum E/W Output Voltage  | Pin 24  |          |                     | 6.5       | V   |
| VEWm               | Minimum E/W Output Voltage  | Pin 24  | 1.8      |                     |           | V   |
| EW <sub>DC</sub>   | For control of Horizontal size. DC Output Voltage with E/W, corner and Keystone inhibited   | Pin 24, see Figure 2<br>Subaddress 11<br>Byte x0000000<br>Byte x1000000<br>Byte x11111111 |          | 2<br>3.25<br>4.2    |           | V<br>V<br>V   |
| TDEW <sub>DC</sub> | DC Output Voltage Thermal Drift   | See <sup>(16)</sup>   |          | 100                 |           | ppm/C   |
| EWpara             | Parabola Amplitude with Max. VAMP,<br>Typ. VPOS, Keystone and Corner inhibit-<br>ed   | Subaddress 0A Byte 11111111 Byte 11000000 Byte 10000000                                   |          | 1.4<br>0.7<br>0     |           | V <sub>PP</sub><br>V <sub>PP</sub><br>V <sub>PP</sub> |
| EWtrack            | Parabola Amplitude Function of VAMP<br>Control (tracking between VAMP and E/<br>W) with Typ. VPOS, Typ. E/W Amplitude,<br>corner and Keystone inhibited <sup>(17)</sup>   | Subaddress 05 Byte 10000000 Byte 11000000 Byte 11111111                                   |          | 0.2<br>0.4<br>0.7   |           | V <sub>PP</sub><br>V <sub>PP</sub><br>V <sub>PP</sub> |
| KeyAdj             | Keystone Adjustment Capability with Typ. VPOS, E/W inhibited, Corner inhibited and Max. Vert. Amplitude (see (17) and Figure 4)   | Subaddress 09<br>Byte 10000000<br>Byte 11111111   |          | 0.4<br>0.4          |           | V <sub>PP</sub>                                       |
| EW Corner          | Corner Adjustment Capability with Typ. VPOS, E/W inhibited, Keystone inhibited and Max. Vertical Amplitude  | Subaddress 10 Byte 11111111 Byte 11000000 Byte 10000000                                   |          | +1.25<br>0<br>-1.25 |           | V <sub>PP</sub><br>V <sub>PP</sub>                    |
| KeyTrack           | Intrinsic Keystone Function of VPOS Control (tracking between VPOS and E/ W) with Max. E/W Amplitude and Max. Vertical Amplitude, Corner inhibited B/A Ratio A/B Ratio    | Subaddress 06  Byte 00000000  Byte 01111111   |          | 0.52<br>0.52        |           |   |
| ASYMMETRIC         | CONTROL THROUGH INTERNAL DYNA   | MIC HORIZONTAL PHASI  | E MODU   | LATION              | l (see Fi | gure 3)   |
| SPBpara            | Side Pin Balance Parabola Amplitude<br>(Figure 3) with Max. VAMP, Typ. VPOS<br>and Parallelogram inhibited <sup>(17 &amp; 18)</sup>                                       | Subaddress 0D<br>Byte 11111111<br>Byte 10000000   |          | +2.8<br>-2.8        |           | %T <sub>H</sub><br>%T <sub>H</sub>                    |
| SPBtrack           | Side Pin Balance Parabola Amplitude<br>function of VAMP Control (tracking be-<br>tween VAMP and SPB) with Max. SPB,<br>Typ. VPOS and Parallelogram inhibited<br>(17 & 18) | Subaddress 05<br>Byte 10000000<br>Byte 11000000<br>Byte 11111111                          |          | 1<br>1.8<br>2.8     |           | %T <sub>H</sub><br>%T <sub>H</sub><br>%T <sub>H</sub> |
| ParAdj             | Parallelogram Adjustment Capability with Max. VAMP, Typ. VPOS and SPB inhibited (17 & 18)   | Subaddress 0E<br>Byte 11111111<br>Byte 11000000   |          | +2.8<br>-2.8        |           | %T <sub>H</sub><br>%T <sub>H</sub>                    |
| Partrack           | Intrinsic Parallelogram Function of VPOS Control (tracking between VPOS and DHPC) with Max. VAMP, Max. SPB and Parallelogram inhibited (17 & 18)  B/A Ratio A/B Ratio     | Subaddress 06  Byte x0000000  Byte x1111111   |          | 0.52<br>0.52        |           |   |



Note: 16 These parameters are not tested on each unit. They are measured during our internal qualification procedure.

Note: 17 With Register 07 at Byte 0xxxxxxx (S correction inhibited) and Register 08 at Byte 0xxxxxxx (C correction inhibited), the sawtooth has a linear shape.

# **MOIRE CANCELLATION SECTION**

**Electrical Characteristics** ( $V_{CC} = 12V$ ,  $T_{amb} = 25^{\circ}C$ )

| Symbol              | Parameter  | Test Conditions   | Min. | Тур.                                 | Max. | Units   |
|---------------------|--|---|------|--------------------------------------|------|---|
| HORIZONTAL          | AND VERTICAL MOIRE   |   |      |                                      |      |   |
| R <sub>MOIRE</sub>  | Minimum Output Resistor to GND   | Pin 3   | 4.7  |                                      |      | kΩ  |
| DacOut              | DC Voltage pin 3 DAC configuration                                       | $R_{MOIRE} = 4.7 k\Omega$<br>sub-address 02<br>Byte 00000000<br>Byte 01000000<br>Byte 01111111  |      | 0.3<br>1.1<br>2.75                   | 3    | V<br>V  |
| HMOIRE              | Moiré pulse (See also Hunlock in 1st PLL section)<br>H Frequency: Locked | R <sub>MOIRE</sub> = 4.7kΩ<br>Sub-address 02<br>Byte 10000000<br>Byte 11000000<br>Byte 11111111 |      | 0<br>0.8<br>2.2                      |      | V <sub>PP</sub><br>V <sub>PP</sub><br>V <sub>PP</sub> |
| T <sub>HMOIRE</sub> | HMoiré pulse period pin 3<br>H Frequency: Locked                         | Sub-address II: 0xxx xxxx 1xxx xxxx   |      | 4.T <sub>H</sub><br>2.T <sub>H</sub> |      |   |
| VMOIRE              | Vertical Moiré<br>(measured on VOUT: Pin 23)                             | Sub-address 0C<br>Byte 11111111   |      | 6                                    |      | mV  |

Note: 18 T<sub>H</sub> is the horizontal period.

# **B+ SECTION**

# **Operating Conditions**

| Symbol  | Parameter                 | Test Conditions                 | Min. | Тур. | Max. | Units |
|---------|---------------------------|---------------------------------|------|------|------|-------|
| FeedRes | Minimum Feedback Resistor | Resistor between Pins 15 and 14 | 5    |      |      | kΩ    |

**Electrical Characteristics** (V<sub>CC</sub> = 12V, T<sub>amb</sub> = 25°C)

| Symbol              | Parameter  | Test Conditions  | Min. | Тур.       | Max. | Units    |
|---------------------|--|--|------|------------|------|----------|
| OLG                 | Error Amplifier Open Loop Gain   | At low frequency (19)  |      | 85         |      | dB       |
| UGBW                | Unity Gain Bandwidth   | See <sup>(19)</sup>  |      | 6          |      | MHz      |
| IRI                 | Feedback Input Bias Current  | Current sourced by Pin 15 (PNP base)                                   |      | 0.2        |      | μΑ       |
| EAOI                | Error Amplifier Output Current   | Current sourced by Pin 14<br>Current sunk by<br>Pin 14 <sup>(20)</sup> | 2    | 1.4        |      | mA<br>mA |
| CSG                 | Current Sense Input Voltage Gain   | Pin 16   |      | 3          |      |          |
| MCEth               | Max Current Sense Input Threshold Voltage  | Pin 16   |      | 1.3        |      | V        |
| ISI                 | Current Sense Input Bias Current   | Current sunk by Pin 16 (PNP base)                                      |      | 1          |      | μА       |
| Tonmax              | Maximum ON Time of the external power transistor   | % of horizontal period,<br>f <sub>o</sub> = 27kHz) <sup>(21)</sup>     |      | 100        |      | %        |
| B+OSV               | B+Output Saturation Voltage  | V <sub>28</sub> with I <sub>28</sub> = 10mA                            |      | 0.25       |      | V        |
| IV <sub>REF</sub>   | Internal Reference Voltage   | On error amp (+) input Subaddress OB: Byte 1000000                     |      | 5          |      | V        |
| V <sub>REFADJ</sub> | Internal Reference Voltage Adjustment Range  | Byte 01111111<br>Byte 00000000   |      | +20<br>-20 |      | %<br>%   |
| PWMSEL              | Threshold for step-up/step-down selection (step-up configuration if V <sub>16</sub> < PWM-SEL) | Pin 16   |      | 6          |      | V        |
| t <sub>FB+</sub>    | Fall Time  | Pin 28   |      | 100        |      | ns       |

Note: 19 These parameters are not tested on each unit. They are measured during our internal qualification procedure which includes characterization on batches coming from corners of our process and also temperature characterization.

Note: 20 To make soft start possible, 0.5mA are sunk when B+ is disabled.

Note: 21 The external power transistor is OFF during 400ns of the HFOCUSCAP discharge

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**Figure 1. Vertical Dynamic Focus Function** 

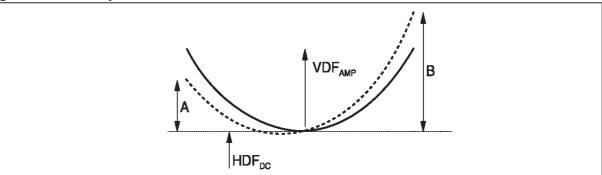


Figure 2. E/W Output

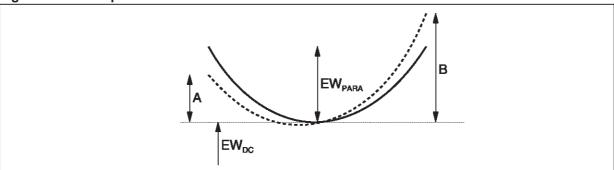


Figure 3. Dynamic Horizontal Phase Control

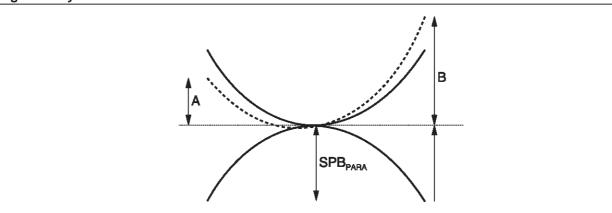
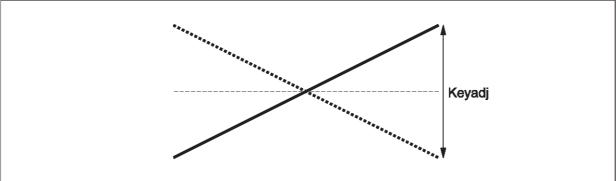


Figure 4. Keystone Effect on E/W Output (PCC Inhibited)



# **TYPICAL OUTPUT WAVEFORMS**

| Function                           | Sub<br>Address | Pin   | Byte                   | Specification  | Effect on Screen |
|------------------------------------|----------------|-------|------------------------|--|------------------|
|                                    |                |       | 10000000               | V <sub>OUTLC</sub> 2.15V   |                  |
| Vertical Size                      | 05             | 23    | 11111111               | V <sub>CUTEC</sub> 3.9V  |                  |
|                                    |                |       | 00000000               | V <sub>OUTDC</sub> = 3.2V  |                  |
|                                    |                |       | 01000000               | V <sub>OUTDC</sub> = 3.6V  |                  |
| Vertical<br>Position<br>DC Control | 06             | 06 23 | 01111111               | V <sub>OUTDC</sub> = 4.0V  | <u> </u>         |
| Vertical<br>S                      | 07             | 07 23 | 0xxxxxxx:<br>Inhibited |  | <b>*</b>         |
| Linearity                          |                |       | 11111111               | $V_{PP} = \frac{\Delta V}{V_{PP}}$ $\frac{\Delta V}{V_{PP}} = 3.5\%$ |                  |

| Function  | Sub<br>Address | Pin   | Byte                     | Specification                           | Effect on Screen |
|---|----------------|-------|--------------------------|---|------------------|
|   |                |       | 0xxxxxxx :<br>Inhibited  |   |                  |
| Vertical<br>C<br>Linearity                        | 08             | 23    | 10000000                 | V <sub>PP</sub> ΔV                      | <b>*</b>         |
|   |                |       | 11111111                 | $V_{PP}$ $\frac{\Delta V}{V_{PP}}$ =+3% |                  |
| Horizontal<br>Size                                |                | 11 24 | x1111111                 | 4.2V                                    |                  |
| 0.23  |                |       | x0000000                 | 2V                                      |                  |
| Horizontal<br>Dynamic<br>Focus with:<br>Amplitude | 03             | 10    | X000 0000 —<br>X111 1111 | 1μs<br>Flyback<br>T <sub>H</sub>        |                  |
| Horizontal<br>Dynamic<br>Focus with:<br>Symmetry  | 04             | 10    | X000 0000 —<br>X111 1111 | 1μs<br>Flyback                          |                  |

| Function                | Sub<br>Address | Pin      | Byte     | Specification             | Effect on Screen     |                           |  |
|-------------------------|----------------|----------|----------|---------------------------|----------------------|---------------------------|--|
|                         |                |          | (E/\     | V + Corner Inhibited)     |                      |                           |  |
| Keystone<br>(Trapezoid) | 09             | 24       | 10000000 | 0.4V EW <sub>DC</sub>     | $\sqrt{}$            |                           |  |
| Control                 |                |          | 11111111 | 0.4V EW <sub>DC</sub>     | $\Delta$             |                           |  |
|                         |                |          | (Keyst   | one + Corner Inhibited)   |                      |                           |  |
| E/W<br>(Pin             | 0A             | 24       | 10000000 | EW <sub>DC</sub> OV       | $\overline{Y}$       |                           |  |
| Cushion)<br>Control     |                |          | 11111111 | EW <sub>DC</sub> 1.4V     |                      |                           |  |
|                         |                |          | (Key     | stone + E/W Inhibited)    |                      |                           |  |
| Corner<br>Control       | 10             | 24       | 24       | 10 24                     | 11111111             | 1.25V<br>EW <sub>DC</sub> |  |
|                         |                |          | 10000000 | EW <sub>DC</sub>          |                      |                           |  |
|                         |                | _        |          | (SPB Inhibited)           |                      |                           |  |
| Parallel-<br>ogram      | 0E             | Internal | 10000000 | - 1 - 2.8% T <sub>H</sub> | $\overline{\lambda}$ |                           |  |
| Control                 |                |          | 11111111 | - 1 - 2.8% T <sub>H</sub> |                      |                           |  |
|                         |                |          | (Pa      | rallelogram Inhibited)    |                      |                           |  |
| Side Pin<br>Balance     | 0D             |          | 10000000 | 2.8%T <sub>H</sub>        | Y                    |                           |  |
| Control                 |                |          | 11111111 | 2.8% T <sub>H</sub>       |                      |                           |  |

| Function                 | Sub<br>Address | Pin | Byte      | Specification       | Effect on Screen |
|--------------------------|----------------|-----|-----------|---------------------|------------------|
| Vertical<br>Dynamic      | 0F             | 10  | X111 1111 | 2.1V T <sub>V</sub> |                  |
| Focus with<br>Horizontal | UP .           | 10  | X000 0000 | 2.1V +0.V           |                  |

# I<sup>2</sup>C BUS ADDRESS TABLE

# Slave Address (8C): Write Mode

# **Sub Address Definition**

|    | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 |  |
|----|----|----|----|----|----|----|----|----|--|
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | Horizontal Drive Selection/Horizontal Duty Cycle |
| 1  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | X-ray Reset/Horizontal Position                  |
| 2  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0  | Horizontal Moiré/H Lock                          |
| 3  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 1  | Sync. Priority/Horizontal Focus Amplitude        |
| 4  | 0  | 0  | 0  | 0  | 0  | 1  | 0  | 0  | Refresh/Horizontal Focus Symmetry                |
| 5  | 0  | 0  | 0  | 0  | 0  | 1  | 0  | 1  | Vertical Ramp Amplitude                          |
| 6  | 0  | 0  | 0  | 0  | 0  | 1  | 1  | 0  | Vertical Position Adjustment                     |
| 7  | 0  | 0  | 0  | 0  | 0  | 1  | 1  | 1  | S Correction                                     |
| 8  | 0  | 0  | 0  | 0  | 1  | 0  | 0  | 0  | C Correction                                     |
| 9  | 0  | 0  | 0  | 0  | 1  | 0  | 0  | 1  | E/W Keystone                                     |
| Α  | 0  | 0  | 0  | 0  | 1  | 0  | 1  | 0  | E/W Amplitude                                    |
| В  | 0  | 0  | 0  | 0  | 1  | 0  | 1  | 1  | B+ Reference Adjustment                          |
| С  | 0  | 0  | 0  | 0  | 1  | 0  | 0  | 0  | Vertical Moiré                                   |
| D  | 0  | 0  | 0  | 0  | 1  | 0  | 0  | 1  | Side Pin Balance                                 |
| Е  | 0  | 0  | 0  | 0  | 1  | 0  | 1  | 0  | Parallelogram                                    |
| F  | 0  | 0  | 0  | 0  | 1  | 0  | 1  | 1  | Vertical Dynamic Focus Amplitude                 |
| 10 | 0  | 0  | 0  | 1  | 0  | 0  | 0  | 0  | E/W Corner                                       |
| 11 | 0  | 0  | 0  | 1  | 0  | 0  | 0  | 1  | H. Moiré Frequency/Horizontal Size Amplitude     |

Slave Address (8D): Read Mode: No sub address needed.

# I<sup>2</sup>C BUS ADDRESS TABLE (continued)

|      | D8                                | D7  | D6  | D5           | D4            | D3         | D2  | D1  |  |
|------|-----------------------------------|-----|-----|--------------|---------------|------------|-----|-----|--|
| WRIT | WRITE MODE                        |     |     |              |               |            |     |     |  |
| 00   | HDrive<br>0, off<br>[1], on       |     |     | Hori         | zontal Duty C | ycle       |     |     |  |
| 00   |                                   | [0] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
| 0.4  | Xray                              |     | Г   | T .          | tal Phase Adj |            |     |     |  |
| 01   | 1, reset<br>[0]                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | HMoiré/HLock<br>1, on<br>[0], off |     |     | ·            | ntal Moiré Am |            |     |     |  |
| 02   |                                   | [0] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | Sync<br>0, Comp<br>[1], Sep       |     |     | Horizon      | tal Focus An  | nplitude   |     |     |  |
| 03   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | Detect                            |     |     | Horizor      | ital Focus Sy | mmetry     |     |     |  |
| 04   | Refresh<br>[0], off               | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | Vramp<br>0, off<br>[1], on        |     |     | Vertical Ran | np Amplitude  | Adjustment |     |     |  |
| 05   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | Test V<br>1, on<br>[0], off       |     |     | Vertical     | Position Adj  | ustment    |     |     |  |
| 06   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | S Select                          |     |     |              | S Correction  |            |     |     |  |
| 07   | 1, on<br>[0]                      | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | C Select<br>1, on<br>[0]          |     |     |              | C Correction  |            |     |     |  |
| 08   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | E/W Key<br>0, off<br>[1]          |     |     | I            | E/W Keystone  | )          |     |     |  |
| 09   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | E/W Sel<br>0, off<br>[1]          |     |     | E            | /W Amplitud   | е          |     |     |  |
| 0A   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | Test H<br>1, on<br>[0], off       |     |     | B + Re       | ference Adju  | stment     |     |     |  |
| 0B   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | V. Moiré<br>1, on<br>[0]          |     |     | Vertic       | al Moiré Amp  | litude     |     |     |  |
| 0C   |                                   | [0] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | SPB Sel<br>0, off<br>[1]          |     |     | Si           | de Pin Balan  | ce         |     |     |  |
| 0D   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |
|      | Parallelo<br>0, off<br>[1]        |     |     |              | Parallelogran | l          |     |     |  |
| 0E   |                                   | [1] | [0] | [0]          | [0]           | [0]        | [0] | [0] |  |



|           | D8  | D7                               | D6                        | D5                    | D4                     | D3                      | D2                     | D1                   |  |
|-----------|---|----------------------------------|---------------------------|-----------------------|------------------------|-------------------------|------------------------|----------------------|--|
|           | Eq. Pulse<br>1, ignore T <sub>H</sub> /2<br>[0], accept all | Vertical Dynamic Focus Amplitude |                           |                       |                        |                         |                        |                      |  |
| 0F        |   | [1]                              | [0]                       | [0]                   | [0]                    | [0]                     | [0]                    | [0]                  |  |
|           | Corner Sel<br>1, on<br>[0], off                             |                                  | E/W Corner                |                       |                        |                         |                        |                      |  |
| 10        |   | [1]                              | [0]                       | [0]                   | [0]                    | [0]                     | [0]                    | [0]                  |  |
|           | H. Moiré Frequency<br>1 F/2<br>[0] F/4                      |                                  | Horizontal Size Amplitude |                       |                        |                         |                        |                      |  |
| 11        |   | [1]                              | [0]                       | [0]                   | [0]                    | [0]                     | [0]                    | [0]                  |  |
| READ MODE |   |                                  |                           |                       |                        |                         |                        |                      |  |
|           | Hlock   | Vlock                            | Xray                      | Polarity Detection    |                        | Sync Detection          |                        |                      |  |
|           | 0, on<br>[1], no  | 0, on<br>[1], no                 | 1, on<br>[0], off         | H/V pol [1], negative | V pol<br>[1], negative | Vext det<br>[0], no det | H/V det<br>[0], no det | V det<br>[0], no det |  |

[x] initial value
Data is transferred with vertical sawtooth retrace.
We recommend setting the unspecified bits to [0] in order to ensure compatibility with future devices.

### **OPERATING DESCRIPTION**

#### 1 GENERAL CONSIDERATIONS

#### 1.1 Power Supply

The typical values of the power supply voltages  $V_{CC}$  and  $V_{DD}$  are 12 V and 5 V respectively. Optimum operation is obtained for  $V_{CC}$  between 10.8 and 13.2 V and  $V_{DD}$  between 4.5 and 5.5 V.

In order to avoid erratic operation of the circuit during the transient phase of VCC switching on, or off, the value of  $V_{CC}$  is monitored: if  $V_{CC}$  is less than 7.5 V typ., the outputs of the circuit are inhibited.

Similarly, before  $V_{DD}$  reaches 4 V, all the I<sup>2</sup>C register are reset to their default value (see I<sup>2</sup>C Control Table).

In order to have very good power supply rejection, the circuit is internally supplied by several voltage references (typ. value: 8.2 V). Two of these voltage references are externally accessible, one for the vertical and one for the horizontal part. They can be used to bias external circuitry (if  $\rm I_{LOAD}$  is less than 5 mA). It is necessary to filter the voltage references by external capacitors connected to ground, in order to minimize the noise and consequently the "jitter" on vertical and horizontal output signals.

### 1.2 I<sup>2</sup>C Control

TDA9111 belongs to the I<sup>2</sup>C controlled device family. Instead of being controlled by DC voltages on dedicated control pins, each adjustment can be done via the I<sup>2</sup>C Interface.

The I<sup>2</sup>C bus is a serial bus with a clock and a data input. The general function and the bus protocol are specified in the Philips-bus data sheets.

The inputs (Data and Clock) are comparators with a 2.2 V threshold at 5 V supply. Spikes of up to 50 ns are filtered by an integrator and the maximum clock speed is limited to 400 kHz.

The data line (SDA) can be used bidirectionally. In read-mode the IC sends reply information (1 byte) to the micro-processor.

The bus protocol prescribes a full-byte transmission in all cases. The first byte after the start condition is used to transmit the IC-address (hexa 8C for write, 8D for read).

#### 1.3 Write Mode

In write mode the second byte sent contains the subaddress of the selected function to adjust (or controls to affect) and the third byte the corresponding data byte. It is possible to send more than one data byte to the IC. If after the third byte

no stop or start condition is detected, the circuit increments automatically by one the momentary subaddress in the subaddress counter (auto-increment mode). So it is possible to transmit immediately the following data bytes without sending the IC address or subaddress. This can be useful to reinitialize all the controls very quickly (flash manner). This procedure can be finished by a stop condition.

The circuit has 18 adjustment capabilities: 3 for the horizontal part, 4 for the vertical, 3 for the E/W correction, 2 for the dynamic horizontal phase control, 2 for the vertical and horizontal Moiré options, 3 for the horizontal and the vertical dynamic focus and 1 for the B+ reference adjustment.

18 bits are also dedicated to several controls (ON/ OFF, Horizontal Forced Frequency, Sync Priority, Detection Refresh and XRAY reset).

#### 1.4 Read Mode

During the read mode the second byte transmits the reply information.

The reply byte contains the horizontal and vertical lock/unlock status, the XRAY activation status, and the horizontal and vertical polarity detection. It also contains the sync detection status which is used by the MCU to assign the sync priority. A stop condition always stops all the activities of the bus decoder and switches to high impedance both the data and clock line (SDA and SCL).

See I<sup>2</sup>C subaddress and control tables.

#### 1.5 Sync Processor

The internal sync processor allows the TDA9111 to accept:

- separated horizontal & vertical TTL-compatible sync signal
- composite horizontal & vertical TTL-compatible sync signal

#### 1.6 Sync Identification Status

The MCU can read (address read mode: 8D) the status register via the I<sup>2</sup>C bus, and then select the sync priority depending on this status.

Among other data this register indicates the presence of sync pulses on H/HVIN, VSYNCIN and (when 12 V is supplied) whether a Vext has been extracted from H/HVIN. Both horizontal and vertical sync are detected even if only 5 V is supplied.

In order to choose the right sync priority the MCU may proceed as follows (see I<sup>2</sup>C Address Table):

- refresh the status register,
- wait at least for 20ms (Max. vertical period),
- read this status register.

Sync priority choice should be:

| Vextd<br>et | H/V<br>det | V<br>det | Sync<br>priority<br>Subaddress<br>03 (D8) | Comment<br>Sync type |
|-------------|------------|----------|---|----------------------|
| No          | Yes        | Yes      | 1   | Separated H&V        |
| Yes         | Yes        | No       | 0   | Composite TTL<br>H&V |

Of course, when the choice is made, we can refresh the sync detections and verify that the extracted Vsync is present and that no sync type change has occurred. The sync processor also gives sync polarity information.

#### 1.7 IC status

The IC can inform the MCU about the 1st horizontal PLL and vertical section status (locked or not) and about the XRAY protection (activated or not). Resetting the XRAY internal latch can be done either by decreasing the  $V_{CC}$  supply or directly resetting it via the  $I^2C$  interface.

#### 1.8 Sync Inputs

Both H/HVIN and VSYNCIN inputs are TTL compatible triggers with hysteresis to avoid erratic detection. Both inputs include a pull up resistor connected to  $V_{DD}$ .

## 1.9 Sync Processor Output

The sync processor indicates on the D8 bit of the status register whether 1st PLL is locked to an incoming horizontal sync. Its level goes to low when locked. This information is also available on pin 3 if sub-address 02 D8 is equal to 1. When PLL1 is unlocked, pin 3 output voltage becomes greater than 6V. When it is locked, the HMoiré waveform is available on pin 3 (max voltage: 3V).

### **2 HORIZONTAL PART**

#### 2.1 Internal Input Conditions

A digital signal (horizontal sync pulse or TTL composite) is sent by the sync processor to the horizontal input. It may be positive or negative (see Figure 5).

Using internal integration, both signals are recognized if Z/T < 25%. Synchronization occurs on the leading edge of the internal sync signal.

The minimum value of Z is 0.7 μs.

Another integration is able to extract the vertical pulse from composite sync if the duty cycle is higher than 25% (typically d = 35%), (see Figure 6).

Figure 5.

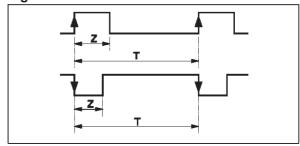
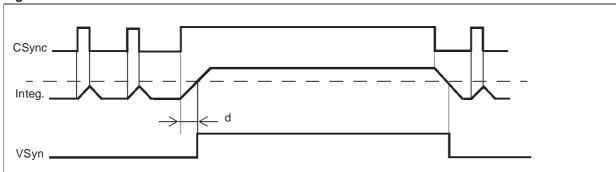


Figure 6.



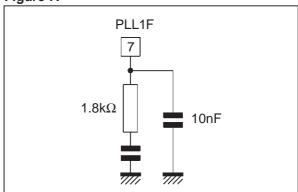
The last feature performed is the removal of these equalization pulses which fall in the middle of a line, to avoid parasitic pulses on the phase comparator (which would be disturbed by missing or extraneous pulses). This last feature is switched on/ off by sub-address 0F D8. By default [0], equalization pulses will not be removed.

### 2.2 PLL1

The PLL1 consists of a phase comparator, an external filter and a voltage-controlled oscillator (VCO). The phase comparator is a "phase/frequency" type designed in CMOS technology. This kind of phase detector avoids locking on wrong frequencies. It is followed by a "charge pump", composed of two current sources: sunk and sourced (typically I =1 mA when locked and I = 140  $\mu$ A when unlocked). This difference between lock/unlock allows smooth catching of the horizontal frequency by PLL1. This effect is reinforced by an internal original slow down system when PLL1 is locked, avoiding the horizontal frequency changing too quickly. The dynamic behavior of PLL1 is fixed by an external filter which integrates the cur-

rent of the charge pump. A "CRC" filter is generally used (see Figure 7 on page 25).

Figure 7.



The PLL1 is internally inhibited during extracted vertical sync (if any) to avoid taking in account missing pulses or wrong pulses on phase comparator. Inhibition is obtained by stopping high and low signals at the input of the charge pump block (see Figure 8 on page 25).

Figure 8.

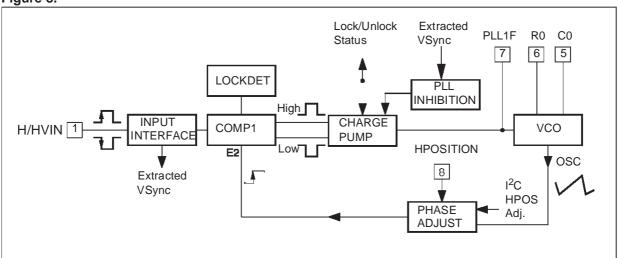
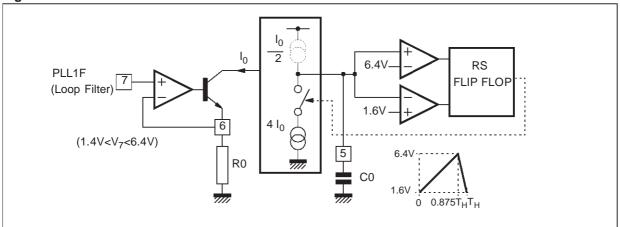


Figure 9.



The VCO uses an external RC network. It delivers a linear sawtooth obtained by the charge and the discharge of the capacitor, with a current proportional to the current in the resistor. The typical thresholds of the sawtooth are 1.6 V and 6.4 V.

The control voltage of the VCO is between 1.4 V and 6.4 V (see Figure 9). The theoretical frequency range of this VCO is in the ratio of 1 to 4.5. The effective frequency range has to be smaller (1 to 4.2) due to clamp intervention on the filter lowest value.

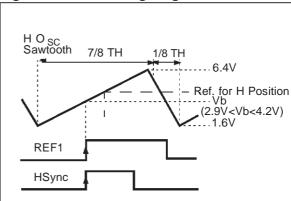
The sync frequency must always be higher than the free running frequency. For example, when using a sync range between 25 kHz and 100 kHz, the suggested free running frequency is 22 kHz.

PLL1 ensures the coincidence between the leading edge of the sync signal and a phase reference REF1 obtained by comparison between the sawtooth of the VCO and an internal DC voltage Vb. Vb is  $I^2$ C adjustable between 2.9 V and 4.2 V (corresponding to  $\pm 10$  %) (see Figure 10).

The TDA9111 also includes a Lock/Unlock identification block which senses in real time whether PLL1 is locked or not on the incoming horizontal sync signal. This information is available through

I<sup>2</sup>C, and also on pin 3 if HLock/Unlock option has been set through Subaddress 02,D8.

Figure 10. PLL1 Timing Diagram



Phase REF1 is obtained by comparison between the sawtooth and a DC voltage adjustable between 2.9 V and 4.2 V.

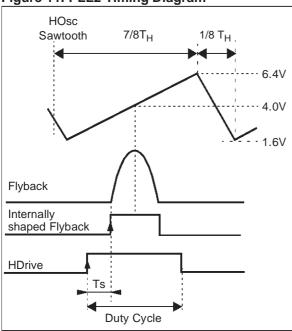
The PLL1 ensures the exact coincidence between the signal phase REF and HSYNC. A  $\pm 10\%$  T<sub>H</sub> phase adjustment is possible around the 3.5V point.

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#### 2.3 PLL2

PLL2 ensures a constant position of the shaped flyback signal in comparison with the sawtooth of the VCO, taking into account the saturation time Ts (see Figure 11)

Figure 11. PLL2 Timing Diagram

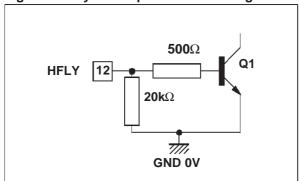


The phase comparator of PLL2 is followed by a charge pump (typical output current: 0.5 mA).

The flyback input consists of an NPN transistor.

The input current must be limited to less than 5 mA (see Figure 12).

Figure 12. Flyback Input Electrical Diagram



The duty cycle is adjustable through I<sup>2</sup>C from 30 % to 65 %. For a safe start-up operation, the initial duty cycle (after power-on reset) is 65% in order to avoid having too long a conduction period of the horizontal scanning transistor.

The maximum storage time (Ts Max.) is (0.44 $T_{H^-}T_{FLY}/2$ ). Typically,  $T_{FLY}/T_H$  is around 20 %, at maximum frequency, which means that Ts max is around 34 % of  $T_H$ .

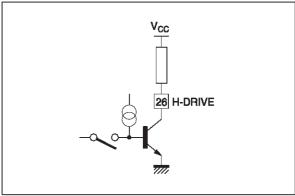
#### 2.4 Output Section

The H-drive signal is sent to the output through a shaping stage which also controls the H-drive duty cycle (I<sup>2</sup>C adjustable) (see Figure 11). In order to secure the scanning power part operation, the output is inhibited in the following cases:

- when V<sub>CC</sub> or V<sub>DD</sub> are too low
- when the XRAY protection is activated
- during the Horizontal flyback
- when the HDrive I<sup>2</sup>C bit control is off.

The output stage consists of a NPN bipolar transistor. Only the collector is accessible (see Figure 13).

Figure 13.



This output stage is intended for "reverse" base control, where setting the output NPN in off-state will control the power scanning transistor in off-state.

The maximum output current is 30mA, and the corresponding voltage drop of the output  $V_{\text{CEsat}}$  is 0.4V Max.

Obviously the power scanning transistor cannot be directly driven by the integrated circuit. An interface has to be added between the circuit and the power transistor either of bipolar or MOS type.

#### 2.5 X-RAY Protection

The X-Ray protection is activated by application of a high level on the X-Ray input (more than 8.2V on Pin 25). It inhibits the H-Drive and B+ outputs.

This activation is internally delayed by 2 lines to avoid erratic detection when short parasitics are present .

This protection is latched; it may be reset either by  $V_{CC}$  switch-off or by  $I^2C$  (see Figure 14 on page 28).

#### 2.6 Horizontal and Vertical Dynamic Focus

For dynamic focus adjustment, the TDA9111 delivers the sum of two signals on pin 10:

- a parabolic waveform at horizontal frequency,
- a parabolic waveform at vertical frequency.

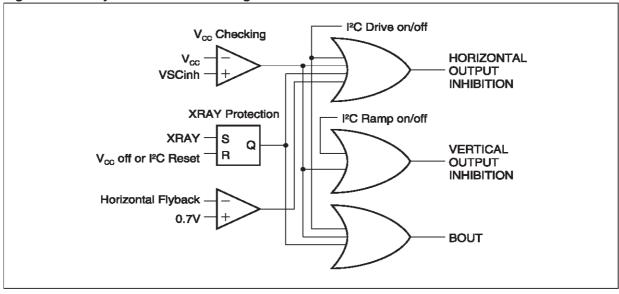
The horizontal parabola comes from a sawtooth in phase advance with flyback pulse middle. The

phase advance versus horizontal flyback middle is kept constant versus frequency (about  $1\mu s$ ).

Symmetry and amplitude are I<sup>2</sup>C adjustable (see Figure 15 on page 29). The vertical parabola is tracked with VPOS and VAMP. Its amplitude can be adjusted. It is also affected by S and C corrections. This positive signal once amplified is to be sent to the CRT focusing grids.

Because the DC/DC converter is triggered by the HFocus sawtooth, it is recommended to connect a capacitor to pin 9, even if HFocus is not needed.

Figure 14. Safety Functions Block Diagram



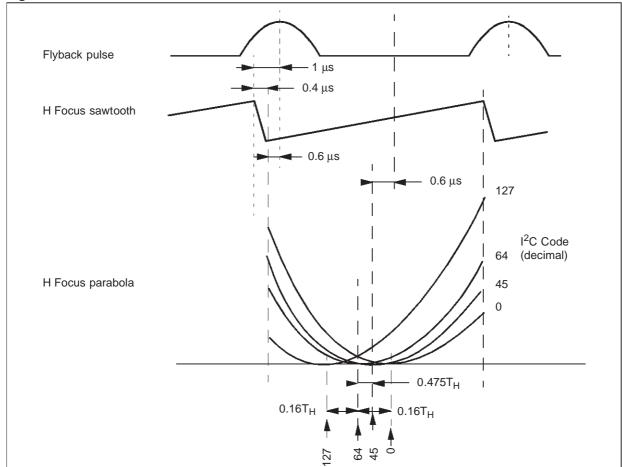


Figure 15. Phase of HFocus Parabola

# 2.7 Horizontal Moiré Output

The Horizontal Moiré output is intended to correct a beat between the horizontal video pixel period and the CRT pixel width.

The Moiré signal is a combination of the horizontal and vertical frequency signals.

To achieve a Moiré cancellation, the Moiré output has to be connected so as to modulate the horizontal position. We recommend introducing this "Horizontal Controlled Jitter" on the ground side of PLL2 capacitor where this "controlled jitter" will directly affect the horizontal position.

The amplitude of the signal is  $I^2C$  adjustable. The H-Moiré frequency can be chosen via the  $I^2C$ .

When sub-address 11 D8=0, Fh is divided by 4. This is recommended for separate scanning and EHV. When D8=1, Fh is divided by 2, which gives a better aspect in the case of common scanning and EHV. The H-Moiré output is combined with the PLL1 horizontal unlock output.

If HMoiré/HLock is selected:

- when PLL1 is unlocked, pin 3 output voltage goes above 6V.
- when PLL1 is locked, the HMoiré signal (up to 2.2V peak) is present on pin 3.

If HMoiré/HLock is not selected, pin 3 can be used as a 0....2.5V DAC.

### 3 VERTICAL PART

#### 3.1 Function

When the synchronization pulse is not present, an internal current source sets the free running frequency. For an external capacitor  $C_{OSC} = 150nF$ , the typical free running frequency is 100Hz.

The typical free running frequency can be calculated by:

fo(Hz) = 
$$1.5 \cdot 10^{-5} \cdot \frac{1}{\text{Cosc}}$$

A negative or positive TTL level pulse applied on Pin 2 (VSYNC) as well as a TTL composite sync on Pin 1 can synchronize the ramp in the range [fmin, fmax] (See Figure 16 on page 31). This frequency range depends on the external capacitor connected on Pin 22. A 150nF ( $\pm$  5%) capacitor is recommended for 50Hz to 185Hz applications.

If a synchronization pulse is applied, the internal oscillator is synchronized immediately but with wrong amplitude. An internal correction then adjusts it in less than half a second. The top value of the ramp (Pin 22) is sampled on the AGC capacitor (Pin 20) at each clock pulse and a transconductance amplifier modifies the charge current of the capacitor so as to adjust the amplitude to the right value.

The Read Status register provides the vertical Lock-Unlock and the vertical sync polarity information

We recommend to use an AGC capacitor with low leakage current. A value lower than 100nA is mandatory.

A good stability of the internal closed loop is reached with a 470nF  $\pm\,5\%$  capacitor value on Pin 20 (VAGC).

# 3.2 I<sup>2</sup>C Control Adjustments

S and C correction shapes can then be added to this ramp. These frequency-independent S and C corrections are generated internally. Their amplitudes are adjustable by their respective I<sup>2</sup>C registers. They can also be inhibited by their select bits.

Finally, the amplitude of this S and C corrected ramp can be adjusted by the vertical ramp amplitude control register.

The adjusted ramp is available on Pin 23 (V<sub>OUT</sub>) to drive an external power stage.

The gain of this stage can be adjusted ( $\pm$  25%) depending on its register value.

The mean value of this ramp is driven by its own  $I^2C$  register (vertical position). Its value is  $VPOS = 7/16 \cdot V_{REF-V} \pm 400 \text{mV}$ .

Usually  $V_{OUT}$  is sent through a resistive divider to the inverting input of the booster. Since VPOS derives from  $V_{REF-V}$ , the bias voltage sent to the non-inverting input of the booster should also derive from  $V_{REF-V}$  to optimize the accuracy (see Application Diagram).

### 3.3 Vertical Moiré

By using the vertical Moiré, VPOS can be modulated from frame to frame. This function is intended to cancel the fringes which appear when the line to line interval is very close to the CRT vertical pitch.

The amplitude of the modulation is controlled by register VMOIRE on sub-address 0C and can be switched-off via the control bit D8.

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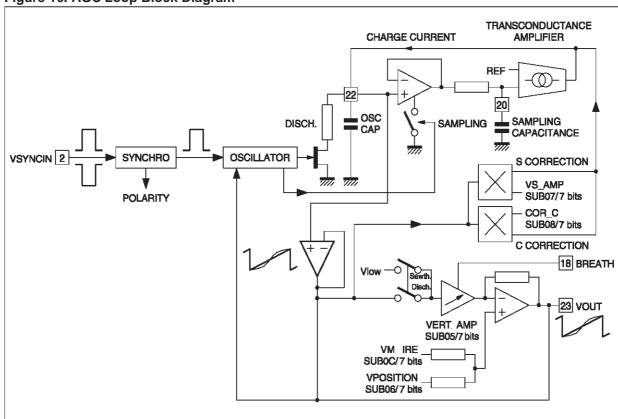


Figure 16. AGC Loop Block Diagram

### 3.4 Basic Equations

In first approximation, the amplitude of the ramp on Pin 23 (VOUT) is:

 $V_{OUT} - VPOS = (V_{OSC} - V_{DCMID}) \cdot (1 + 0.3 (V_{AMP}))$ where:

 $V_{DCMID}$  = 7/16  $V_{REF}$  (middle value of the ramp on Pin 22, typically 3.6V)

 $V_{OSC} = V_{22}$  (ramp with fixed amplitude)

 $V_{AMP} = -1$  for minimum vertical amplitude register value and +1 for maximum

VPOS is calculated by:

 $VPOS = V_{DCMID} + 0.4 V_{P}$ 

where  $V_P = -1$  for minimum vertical position register value and +1 for maximum.

The current available on Pin 22 is:

$$I_{OSC} = \frac{3}{8} \cdot V_{REF} \times C_{OSC} \times f$$

where  $C_{OSC}$  = capacitor connected on Pin 22 and f = synchronization frequency.

#### 3.5 Geometric Corrections

The principle is represented in Figure 17 on page 32.

Starting from the vertical ramp, a parabola-shaped current is generated for E/W correction (also known as Pin Cushion correction), dynamic horizontal phase control correction, and vertical dynamic focus correction.

The parabola generator is made by an analog multiplier, the output current of which is equal to:

$$DI = k \cdot (V_{OUT} - V_{DCMID})^2$$

where  $V_{\mbox{\scriptsize OUT}}$  is the vertical output ramp (typically

between 2 and 5V) and  $V_{DCMID}$  is 3.6V (for  $V_{REF-V}$  = 8.2V). The VOUT sawtooth is typically centered on 3.6V. By changing the vertical position, the sawtooth shifts by  $\pm 0.4$ V.

To provide good screen geometry for any end user adjustment, the TDA9111 has the "geometry tracking" feature which automatically adapts the parabola shape, depending on the vertical position and size.

Due to the large output stage voltage range (E/W Pin Cushion, Keystone, E/W Corner), the combination of the tracking function, maximum

vertical amplitude, maximum or minimum vertical position and maximum gain on the DAC control may lead to output stage saturation. This must be avoided by limiting the output voltage with appropriate I<sup>2</sup>C register values.

For the E/W part and the dynamic horizontal phase control part, a sawtooth-shaped differential current in the following form is generated:

$$\Delta I' = k' \cdot (V_{OUT} - V_{DCMID})$$

Then  $\Delta I$  and  $\Delta I$ ' are added and converted into voltage for the E/W part.

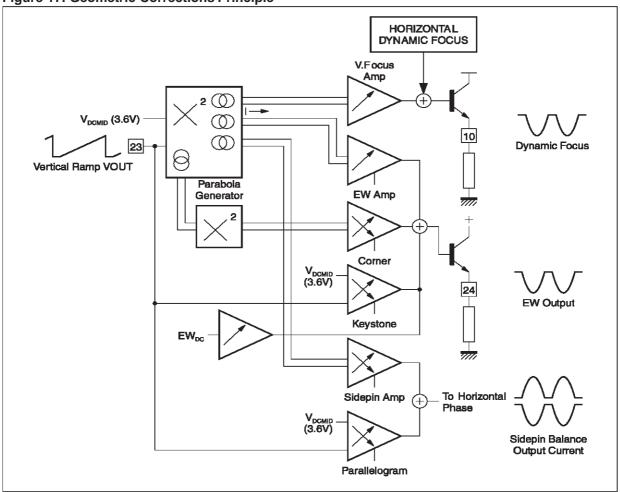
Each of the three E/W components or the two dynamic horizontal phase control components may be inhibited by their own I<sup>2</sup>C select bit.

The E/W parabola is available on Pin 24 via an emitter follower output stage which has to be biased by an external resistor ( $10k\Omega$  to ground). Since stable in temperature, the device can be DC coupled with external circuitry (mandatory to obtain H Size control).

The vertical dynamic focus is combined with the horizontal focus on Pin 10.

The dynamic horizontal phase control drives internally the H-position, moving the HFLY position on the horizontal sawtooth in the range of  $\pm 2.8~\% T_H$  both for side pin balance and parallelogram.

Figure 17. Geometric Corrections Principle



3.6 E/W

 $\begin{aligned} & \mathsf{EWOUT} = \mathsf{EW}_{\mathsf{DC}} + \mathsf{K1} \; (\mathsf{V}_{\mathsf{OUT}} - \mathsf{V}_{\mathsf{DCMID}}) \; + \\ & \mathsf{K2} \; (\mathsf{V}_{\mathsf{OUT}} - \mathsf{V}_{\mathsf{DCMID}})^2 + \; \mathsf{K3} \; (\mathsf{V}_{\mathsf{OUT}} - \mathsf{V}_{\mathsf{DCMID}})^4 \end{aligned}$ 

K1 is adjustable by the keystone I<sup>2</sup>C register. K2 is adjustable by the E/W amplitude I<sup>2</sup>C register. K3 is adjustable by the E/W corner I<sup>2</sup>C register.

### 3.7 Dynamic Horizontal Phase Control

 $I_{OUT} = K4 (V_{OUT} - V_{DCMID}) + K5 (V_{OUT} - V_{DCMID})^2$ 

K4 is adjustable by the parallelogram I<sup>2</sup>C register. K5 is adjustable by the side pin balance I<sup>2</sup>C register

### 4 DC/DC CONVERTER PART

This unit controls the switch-mode DC/DC converter. It converts a DC constant voltage into the B+ voltage (roughly proportional to the horizontal frequency) necessary for the horizontal scanning.

This DC/DC converter can be configured either in step-up or step-down mode. In both cases it operates very similarly to the well known UC3842.

### 4.1 Step-up Mode

### **Operating Description**

- The power MOS is switched ON during the flyback (at the beginning of the positive slope of the horizontal focus sawtooth).
- The power MOS is switched OFF when its current reaches a predetermined value. For this purpose, a sense resistor is inserted in its source. The voltage on this resistor is sent to Pin16 (I<sub>SENSE</sub>).
- The feedback (coming either from the EHV or from the flyback) is divided to a voltage close to 5.0V and compared to the internal 5.0V reference (I<sub>VREF</sub>). The difference is amplified by an error amplifier, the output of which controls the power MOS switch-off current.

#### **Main Features**

- Switching synchronized on the horizontal frequency,
- B+ voltage always higher than the DC source,
- Current limited on a pulse-by-pulse basis.

The DC/DC converter is disabled:

- when V<sub>CC</sub> or V<sub>DD</sub> are too low,
- when X-Ray protection is latched,
- directly through I<sup>2</sup>C bus.

When disabled, BOUT is driven to GND by a 0.5mA current source. This feature allows to implement externally a soft start circuit.

#### 4.2 Step-down Mode

In step-down mode, the  $I_{SENSE}$  information is not used any more and therefore not sent to the Pin16. This mode is selected by connecting this Pin16 to a DC voltage higher than 6V (for example  $V_{REF-V}$ ).

#### **Operating Description**

- The power MOS is switched ON as for the stepup mode.
- The feedback to the error amplifier is done as for the step-up mode.
- The power MOS is switched OFF when the HFO-CUSCAP voltage gets higher than the error amplifier output voltage.

#### **Main Features**

- Switching synchronized on the horizontal frequency,
- B+ voltage always lower than the DC source,
- No current limitation.

## 4.3 Step-up and Step-down Mode Comparison

In step-down mode the control signal is inverted compared with the step-up mode. This, for the following reason:

- In step-up mode, the switch is a N-channel MOS referenced to ground and made conductive by a high level on its gate.
- In step-down, a high-side switch is necessary. It can be either a P- or a N-channel MOS.
  - For a P-channel MOS, the gate is controlled directly from Pin 28 through a capacitor (this allows to spare a Transformer). In this case, a negative-going pulse is needed to make the MOS conductive. Therefore it is necessary to invert the control signal.
  - For a N-channel MOS, a transformer is needed to control the gate. The polarity of the transformer can be easily adapted to the negative-going control pulse.

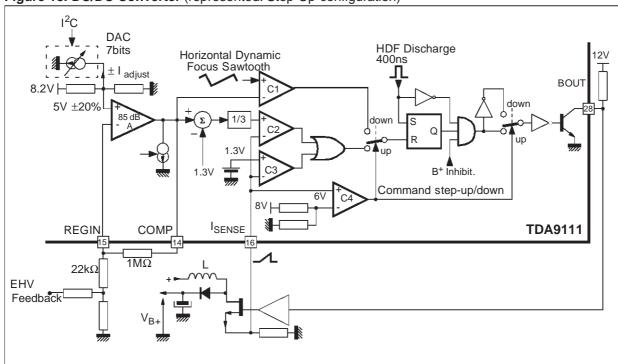


Figure 18. DC/DC Converter (represented: Step-Up configuration)

# **INTERNAL SCHEMATICS**

Figure 19.

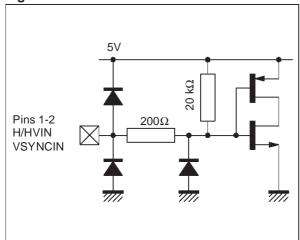


Figure 22.

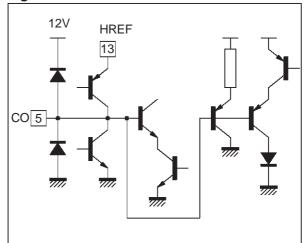


Figure 20.

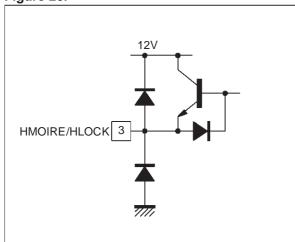


Figure 23.

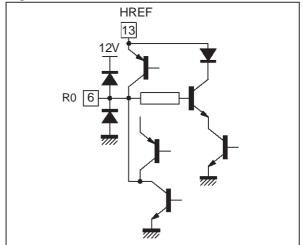


Figure 21.

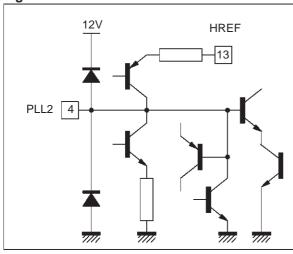


Figure 24.

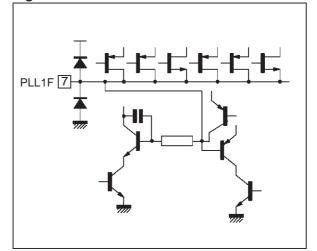


Figure 25.

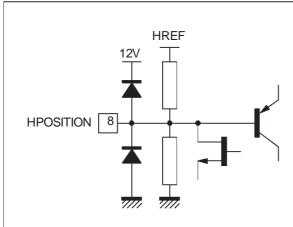


Figure 26.

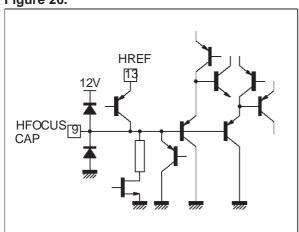


Figure 27.

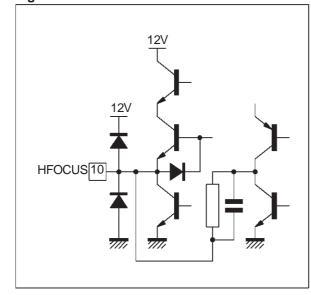


Figure 28.

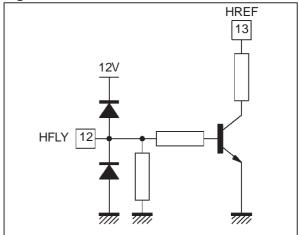


Figure 29.

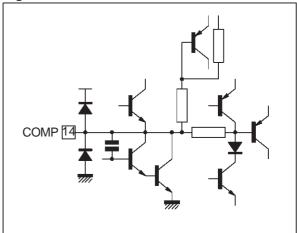


Figure 30.

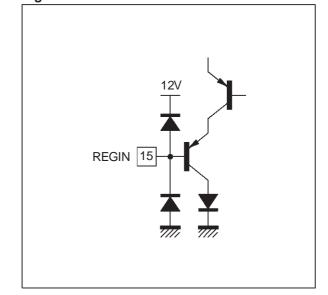


Figure 31.

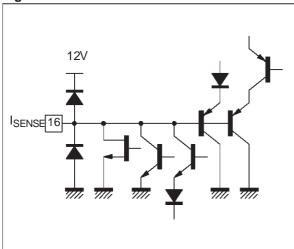


Figure 32.

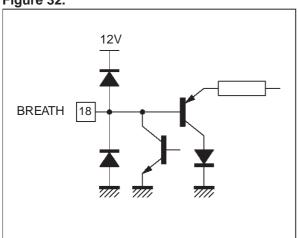


Figure 33.

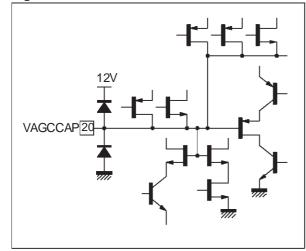


Figure 34.

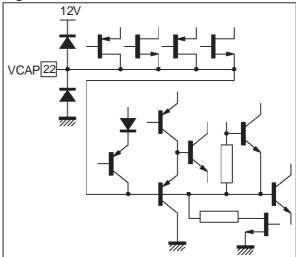


Figure 35.

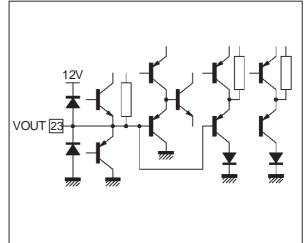


Figure 36.

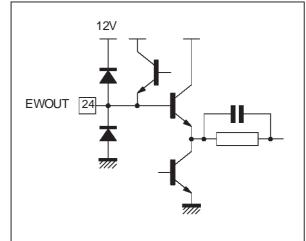


Figure 37.

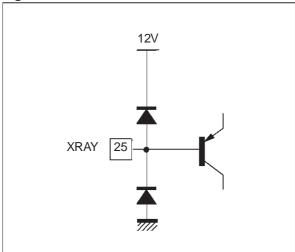


Figure 38.

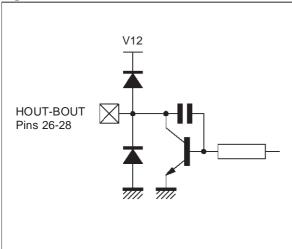
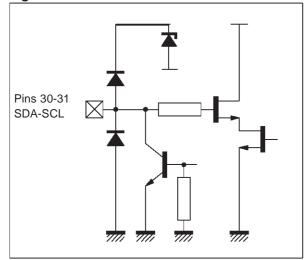


Figure 39.



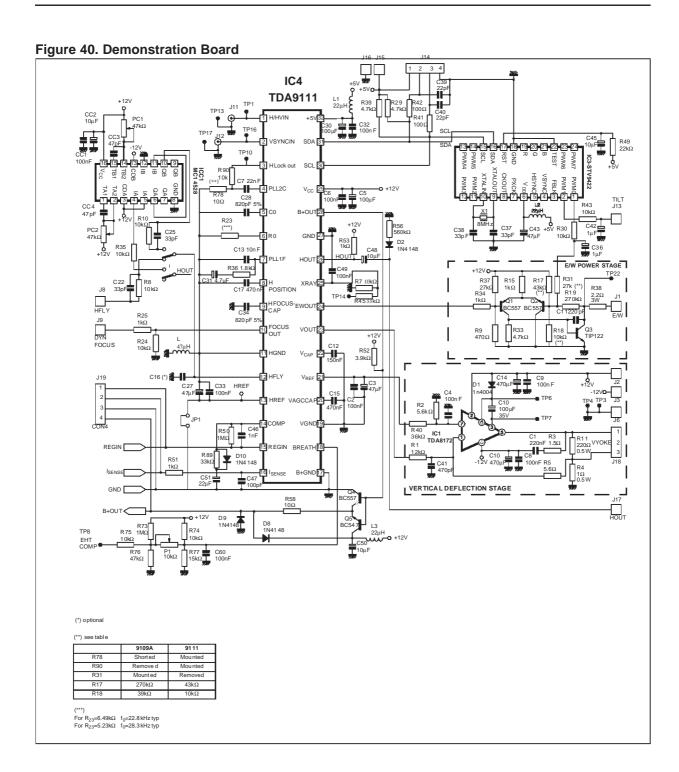


Figure 41.

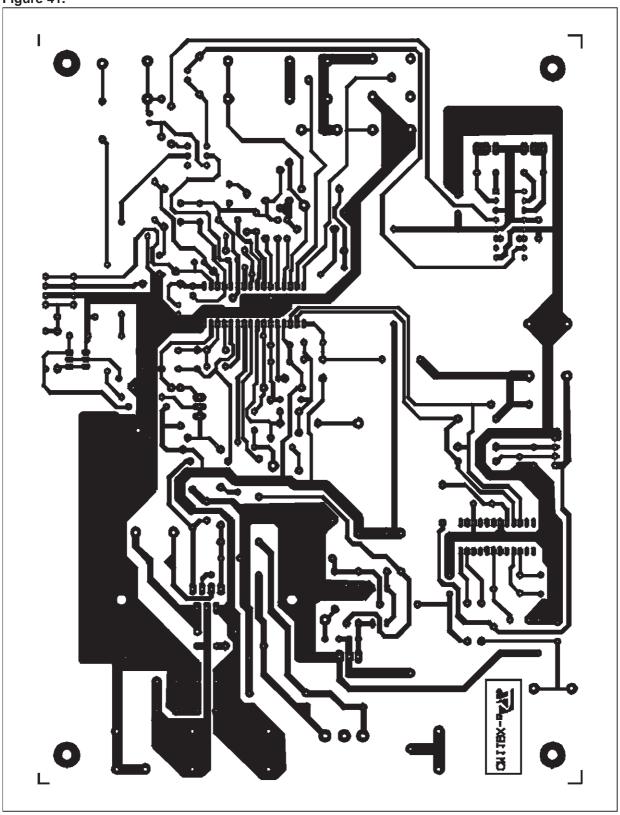
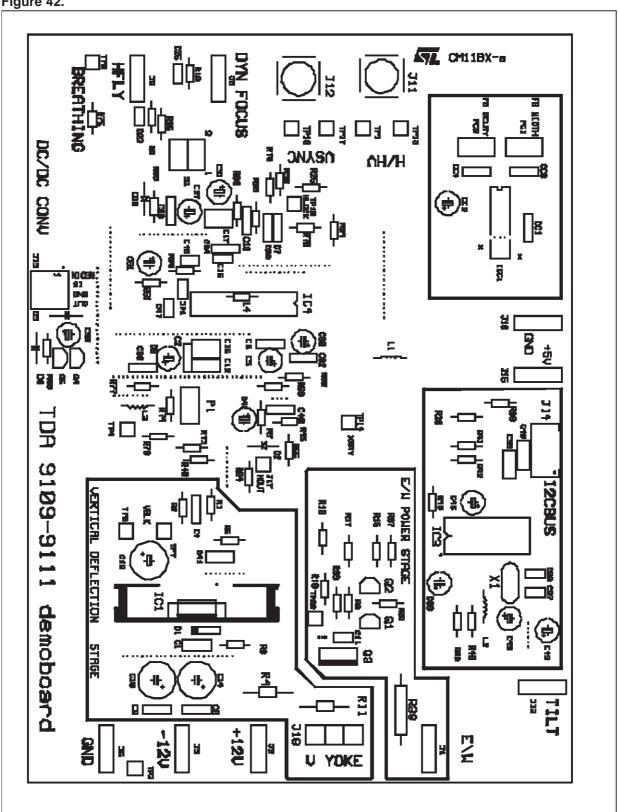
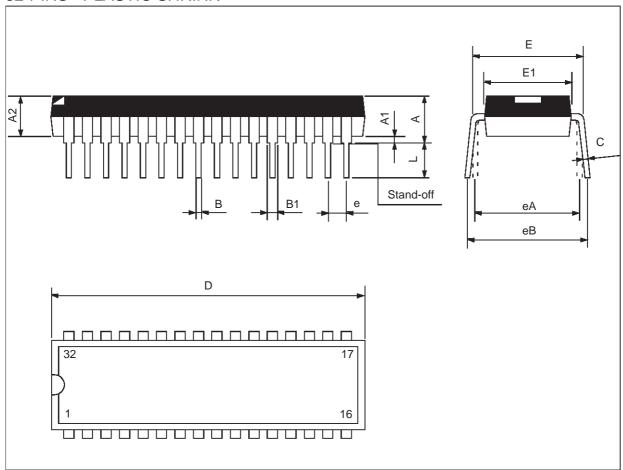


Figure 42.



# **PACKAGE MECHANICAL DATA**

# 32 PINS - PLASTIC SHRINK



| Dimensions | Millimeters |       |       | Inches |       |       |  |
|------------|-------------|-------|-------|--------|-------|-------|--|
| Dimensions | Min.        | Тур.  | Max.  | Min.   | Тур.  | Max.  |  |
| А          | 3.556       | 3.759 | 5.080 | 0.140  | 0.148 | 0.200 |  |
| A1         | 0.508       |       |       | 0.020  |       |       |  |
| A2         | 3.048       | 3.556 | 4.572 | 0.120  | 0.140 | 0.180 |  |
| В          | 0.356       | 0.457 | 0.584 | 0.014  | 0.018 | 0.023 |  |
| B1         | 0.762       | 1.016 | 1.397 | 0.030  | 0.040 | 0.055 |  |
| С          | .203        | 0.254 | 0.356 | 0.008  | 0.010 | 0.014 |  |
| D          | 27.43       | 27.94 | 28.45 | 1.080  | 1.100 | 1.120 |  |
| E          | 9.906       | 10.41 | 11.05 | 0.390  | 0.410 | 0.435 |  |
| E1         | 7.620       | 8.890 | 9.398 | 0.300  | 0.350 | 0.370 |  |
| е          |             | 1.778 |       |        | 0.070 |       |  |
| eA         |             | 10.16 |       |        | 0.400 |       |  |
| eВ         |             |       | 12.70 |        |       | 0.500 |  |
| L          | 2.540       | 3.048 | 3.810 | 0.100  | 0.120 | 0.150 |  |

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